

# 150KHz, 2A PWM BUCK DC/DC CONVERTER

### Description

The HX1509 series are monolithic IC designed for a step- down DC/DC converter, and own the ability of driving a 2A load without additional transistor. It saves board space.

The external shutdown function can be controlled by logic level and then come into standby mode. The internal compensation makes feedback control having good line and load regulation without external design. Regarding protected function, thermal shutdown is to prevent over temperature operating from damage, and current limit is against over current operating of the output switch. If current limit function occurs and VFB is down below 0.5V, the switching frequency will be reduced. The HX1509 series operates at a switching frequency of 150KHz thus allow smaller sized filter components than what would be needed with lower frequency switching regulators. Other features include a guaranteed $\pm 4\%$  tolerance on output voltage under specified input voltage and output load conditions, and  $\pm 15\%$  on the oscillator frequency. The output version included fixed 3.3V, 5V, 12V, and an adjustable type. The chips are available in a standard 8-lead SOP-8 package.

#### Features

- Output Voltage: 3.3V, 5V, 12V and Adjustable Output Version
- Adjustable Version Output Voltage Range, 1.23V to 18V+4%
- 150KHz +15% Fixed Switching Frequency
- Voltage Mode Non-Synchronous PWM Control
- Thermal-Shutdown and Current-Limit Protection
- ON/OFF Shutdown Control Input
- Operating Voltage can be up to 22V
- Output Load Current: 2A
- SOP-8L Packages
- Low Power Standby Mode
- Built-in Switching Transistor On Chip
- Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/ RoHS Compliant

#### Applications

- Simple High-Efficiency Step-Down Regulator
- On-Card Switching Regulators
- Positive to Negative Converter

#### **Ordering Information**

DEVICE	Package Type	MARKING	Packing	Packing Qty
HX1509D-3.3RG	SOP8	HX1509-3.3	REEL	2500pcs/Reel
HX1509D-5.0RG	SOP8	HX1509-5.0	REEL	2500pcs/Reel
HX1509D-12RG	SOP8	HX1509-12	REEL	2500pcs/Reel
HX1509D-ADJRG	SOP8	HX1509-ADJ	REEL	2500pcs/Reel



### **Pin Assignments**



# **Typical Application Circuit**

(1) Fixed Type Circuit





#### (3) Delay Start Circuit



## **Pin Descriptions**

Pin Name	Description
VIN	Operating voltage input
Output	Switching output
GND	Ground
FB	Output voltage feedback control
SD	ON/OFF Shutdown



### **Functional Block Diagram**



# **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD MM	Machine Model ESD Protection	200	V
VIN	Supply Voltage	+24	V
VSD	ON/OFF Pin Input Voltage	-0.3 to +18	V
VFB	Feedback Pin Voltage	-0.3 to +18	V
Vout	Output Voltage to Ground	-1	V
PD	Power Dissipation	Internally Limited	W
TST	Storage Temperature	-65 to +150	°C
TJ	Operating Junction Temperature	-40 to +125	°C

### **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
Ιουτ	Output Current	0	2	А
VOP	Operating Voltage	4.5	22	V
TA	Operating Ambient Temperature	-20	85	°C



### **Electrical Characteristics**

Unless otherwise specified, VIN = 12V for 3.3V, 5V, adjustable version and VIN = 18V for the 12V version. ILOAD = 0.5A Specifications with boldface type are for full operating temperature range, the other type are for TJ =  $25^{\circ}$ C.

Symbol	Para	meter	Con	ditions	Min	Тур.	Max	Unit	
	P Foodbook Biog Current		V <sub>FB</sub> = 1.3V			10	-50	n۸	
ГВ	FB Feedback Blas Culterit			version only)		-10	-100	ΠA	
				127	150	173			
1050	Oscillator Fre	quency					173	KHZ	
Feed	Oscillator Fre	quency of	When curren	t limit occurred	10	20	50		
- 3CF	Short Circuit I	Protect	and $V_{FB} < 0.5$	5V, Ta = 25 °C	10	30	50	ΝΠΖ	
			І <sub>ОUT</sub> = 2А				1.4		
VSAT	Saturation Vo	oltage	No outside ci	ircuit		1.25	15	V	
			V <sub>FB</sub> = 0V forc	e driver on			1.5		
DC	Max. Duty Cy	cle (ON)	V <sub>FB</sub> = 0V forc	e driver on		100		0/2	
	Min. Duty Cyc	cle (OFF)	V <sub>FB</sub> = 12V for	rce driver off		0		70	
		Current Limit							
ICL	Current Limit			ircuit	3			А	
				V <sub>FB</sub> = 0V force driver on					
	Output = 0	Output	No outside circuit		No		-200	ıιΔ	
۱L		Leakage	V <sub>FB</sub> = 12V force driver off				-200	uA	
	Output = -1	Current	V <sub>IN</sub> = 22V	Bar	1	-5		mA	
Ι <sub>Q</sub>	Quiescent Cu	ırrent	V <sub>FB</sub> = 12V for	ce driver off	C.	5	10	mA	
ICTOV			ON/OFF pip = $F/A/=22/4$		and a	70	150		
-5101		scenicurreni	ON/OFF pin = 500 N = 220		01	70	200	uA	
VIL	ON/OFF Pin	Logic Input	Low (regulator ON)		_	1 2	0.6		
VIH	Threshold Vo	ltage	High (regulat	tor OFF)	2.0	1.5	-	V	
L.	IH ON/OFF Pin Logic Input Current		V <sub>LOGIC</sub> = 2.5V (OFF)				0.01		
ІН							-0.01		
IL	ON/OFF Pin	ON/OFF Pin Input Current		$V_{LOGIC} = 0.5V$ (ON)		-0.1	-1	uA	
θJA	Thermal Resi	istance	SOP-8L Junction tocase			15		°C/W	
	θJC Thermal Resistance with a copper area of approximately 3 in <sup>2</sup>		hermal Resistance ith a copper area of SOP-8L Junction to						
θJC						70		°C/W	
			$\sim$	ampient					

### Electrical Characteristics (Continued)

Specifications with boldface type are for full operating temperature range, the other type are for TJ = 25°C.

	Symbol	Parameter	Conditions	VMin	Тур.	VMax	Unit
HX1509-ADJ	V <sub>FB</sub>	Output Feedback	$4.5V \le V_{IN} \le 22V$ $0.2A \le I_{LOAD} \le 2A$ $V_{OUT}$ programmed for 3V	1.193 1.18	1.23	1.267 1.28	V
		Efficiency	$V_{IN} = 12V$ , $I_{LOAD} = 2A$	76	76		%
HX1509-3.3V	VOUT	Output Voltage	$4.75V \le V_{IN} \le 22V$ $0.2A < I_{LOAD} < 2A$	3.168 3.135	3.3	3.432 3.465	V
		Efficiency	V <sub>IN</sub> = 12V, I <sub>LOAD</sub> = 2A	78	78		%
HX1509-5V	VOUT	Output Voltage	$7V \leq V_{IN} \leq 22V$ $0.2A < I_{LOAD} < 2A$	4.8 4.75	5	5.2 5.25	V
		Efficiency	$V_{IN} = 12V$ , $I_{LOAD} = 2A$	83	83		%
HX1509-12V	VOUT	Output Voltage	$15V \le V_{IN} \le 22V$ $0.2A \le I_{LOAD} \le 2A$	11.52 11.4	12	12.48 12.6	V
		Efficiency	V <sub>IN</sub> = 15V, I <sub>LOAD</sub> = 2A	90	90		%



### **Typical Performance Characteristics**



-50 -30 -10

7

6 5 Switch ON

Temperature (TA) (°C)

70

90 110 130 150

10 30 50 35

30

-50 -30 -10 10 30

50

Temperature (TA) (°C)

70 90 110 130 150



#### Typical Performance Characteristics (Continued)







HX1509 Output Voltage vs. Temperature (V<sub>IN</sub>=12V, lo=2A)



HX1509 ON/OFF Current vs. ON/OFF Voltage (V<sub>IN</sub>=12V)



HX1509 Feedback Current vs. Temperature (V<sub>IN</sub>=12V, V<sub>OUT</sub>=5V, Vfb=1.3V)





### Typical Performance Characteristics (Continued)



Output Current (mA)

Output Current (mA)



### **Functions Description**

#### **Pin Functions**

+Vin

This is the positive input supply for the IC switching regulator. A suitable input bypass capacitor must be presented at this pin to minimize voltage transients and to supply the switching currents needed by the regulator.

#### Ground

Circuit ground.

#### Output

Internal switch. The voltage at this pin switches between (+VIN – VSAT) and approximately – 0.5V, with a duty cycle of approximately VOUT / VIN. To minimize coupling to sensitive circuitry, the PC board copper area connected to this pin should be minimized.

#### Feedback

Senses the regulated output voltage to complete the feedback loop.

#### SD

Allows the switching regulator circuit to be shutdown using logic level signals thus dropping the total input supply current to approximately 150uA. Pulling this pin below a threshold voltage of approximately 1.3V turns the regulator on, and pulling this pin above 1.3V (up to a maximum of 18V) shuts the regulator down. If this shutdown feature is not needed, the SD pin can be wired to the ground pin.

#### Thermal Considerations

The SOP-8L package needs a heat sink under most conditions. The size of the heat sink depends on the input voltage, the output voltage, the load current and the ambient temperature. The HX1509 junction temperature rises above ambient temperature for a 2A load and different input and output voltages. The data for these curves was taken with the HX1509 (SOP-8L package) operating as a buck-switching regulator in an ambient temperature of 250 C (still air). These temperature increments are all approximate and are affected by many factors. Higher ambient temperatures require more heat sinker.

For the best thermal performance, wide copper traces and generous amounts of printed circuit board copper should be used in the board layout (One exception is the output (switch) pin, which should not have large areas of copper). Large areas of copper provide the best transfer of heat (lower thermal resistance) to the surrounding air, and moving air lowers the thermal resistance even further.

Package thermal resistance and junction temperature increments are all approximate. The increments are affected by a lot of factors. Some of these factors include board size, shape, thickness, position, location, and even board temperature. Other factors are, trace width, total printed circuit copper area, copper thickness, single or double-sided, multi-layer board and the amount of solder on the board.

The effectiveness of the PC board to dissipate heat also depends on the size, quantity and spacing of other components on the board, as well as whether the surrounding air is still or moving. Furthermore, some of these components such as the catch diode will add heat to the PC board and the heat can vary as the input voltage changes. For the inductor, depending on the physical size, type of core material and the DC resistance, it could either act as a heat sink taking heat away from the board, or it could add heat to the board.



# **Physical Dimensions**

SOP8 (150mil)



Dimensions In Millimeters(SOP8)									
Symbol:	A	A1	В	С	C1	D	Q	а	b
Min:	1.35	0.05	4.90	5.80	3.80	0.40	0°	0.35	1 07 860
Max:	1.55	0.20	5.10	6.20	4.00	0.80	8°	0.45	1.27 030

### **IMPORTANT STATEMENT:**

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